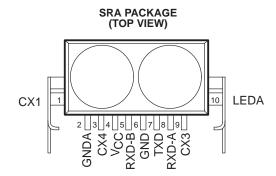
- Fully Compliant with IrDA 1.1 (4 MBPS)
- Compatible with ASK, HP-SIR and TV Remote
- No Programming Required to Switch Speeds
- Backward Compatible to Slower IrDA Speeds
- Excellent Noise Immunity
- Fully Supportable by all Interface Chips
- Designed to Compensate for Light Loss Caused by Cosmetic Windows



description

The TSLM1100 is an infrared transceiver that provides the interface between logic and IR signals for through-air, serial, half-duplex IR data links. The TSLM1100 is compliant with the Infrared Data Association (IrDA) 1.1 physical-layer specification. Additionally, the TSLM1100 is compatible with ASK, HP-SIR and TV Remote standards.

The TSLM1100 is a hybrid device that includes a high-speed AlGaAs 870-nm LED, a silicon intrinsic PN junction (PIN) diode, and a LinCMOS transceiver integrated circuit. This IC has the LED driver and a receiver that provides two output signals: RXD-A for data rates from 2.4 kb/s to 115.2 kb/s and RXD-B for data rates of 576 kb/s to 4.0 Mb/s.

The device is encapsulated in a visible-light-rejecting plastic package that has integral lenses for the LED and the PIN diode. The receiver lens increases the effective area of the PIN diode to increase sensitivity. The LED lens is designed to provide a beam angle of \pm 30°. The receiver outputs pulse low when an IR signal is detected. The power supply for both PIN diode and LED should be filtered to minimize noise from external sources.

This transceiver is well suited for a wide variety of IR interface applications including: PC notebooks, PDAs, pagers, printers, cameras, LANs, telephones and industrial handheld devices.

FUNCTION TABLE

| INPUTS | | OUTPUTS | | | |
|--------|----------------------|---------------------|-------|------|--|
| TXD | Ee | l _{e(LED)} | RXD-B | | |
| VIH | Х | High | NV | NV | |
| VIL | E _{I(IH)} † | Low | Low | NV | |
| VIL | E _{I(IH)} ‡ | Low | NV | Low | |
| VIL | E _{I(IL)} | Low | High | High | |

X – don't care,

NV - not valid

† Data rates up to 115.2 kb/s

‡ Data rates > 115.2 kb/s



Terminal Functions

| PIN | | DESCRIPTION | | | | |
|-------|-----|----------------------------------|--|--|--|--|
| NAME | NO. | DESCRIPTION | | | | |
| CX1 | 1 | Photodiode bypass capacitor | | | | |
| GNDA | 2 | Analog ground | | | | |
| CX4 | 3 | Averaging capacitor | | | | |
| Vcc | 4 | Supply voltage | | | | |
| RXD-B | 5 | Receiver data output – Channel B | | | | |
| GND | 6 | Ground | | | | |
| TXD | 7 | Transmitter data input | | | | |
| RXD-A | 8 | Receiver data output – Channel A | | | | |
| CX3 | 9 | Threshold capacitor | | | | |
| LEDA | 10 | LED anode | | | | |

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

| Supply voltage, V _{CC} 7 V |
|--|
| LED anode voltage range, V _{I(LEDA)} |
| Receiver data output voltage range: V _{O(RXD-A)} |
| $V_{O(RXD-B)}$ |
| Average LED current, I _{I(LED)(avg)} : Direct current |
| Pulsed, ≤ 90-μs pulse width, ≤ 25% duty cycle |
| Peak LED current, $I_{I(LED)(PK)}$: \leq 90- μ s pulse width, \leq 25% duty cycle |
| ` ´ ≤ 2-μs pulse width, ≤ 10% duty cycle |
| Transmitter data input current range, I _{I(TXD)} —12 mA to 12 mA |
| Storage temperature range, T _{stg} –20°C to 85°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

| | CONDITIONS | MIN | MAX | UNITS |
|--|--|--------|------|--------------------|
| Supply voltage, V _{CC} | | 4.75 | 5.25 | V |
| Logic high transmitter input voltage, VIH | | 4.25 | 5.25 | V |
| Logic low transmitter input voltage, V _{IL} | | 0.0 | 0.3 | V |
| Logic high receiver input irrediance F | For in-band signals ≤ 116 kb/s | 0.0036 | 500 | mW/cm ² |
| Logic high receiver input irradiance, E _{e(IH)} | For in-band signals ≥ 576 kb/s | 0.0090 | 500 | mW/cm ² |
| Logic low receiver input irradiance, E _{e(IL)} | For in-band signals | | 0.3 | μW/cm ² |
| LED (logic high) Current pulse amplitude, I _{I(LEDA)} | | 400 | 660 | mA |
| Receiver setup time | For full sensitivity after transmitting | | 1.0 | ms |
| Receiver signal rate, RXD-A | | 2.4 | 116 | kb/s |
| Receiver signal rate, RXD-B | | 0.576 | 4 | Mb/s |
| Ambient light | See IrDA serial infrared physical link specification, 1.1e Appendix A for Ambient levels and Appendix B | | | |
| Operating temperature, TA | Case to ambient thermal resistance ≤ 50°C/W | 0 | 70 | °C |



electrical characteristics at V_{CC} = 5 V, T_A = 25 $^{\circ}C$ (unless otherwise noted); test conditions represent worst-case values for the parameters under test

| PARAMETER | | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------|---|----------------------------|--|----------------------|-----|------|------|
| VOL | Low-level output voltage, receiver data | RXD-A | $\label{eq:lossymmetric} \begin{split} I_O &= 1 \text{ mA},\\ \text{for in-band } E_e &\geq 3.6 \ \mu\text{W/cm}^2,\\ \phi^{1/2} &\leq 15^\circ \end{split}$ | | | 0.5 | V |
| | | RXD-B | I_O = 1 mA, for in-band $E_e \ge 9 \ \mu \text{W/cm}^2$, $\phi^{1/2} \le 15^\circ$ | | | 0.5 | V |
| VOH | High-level output voltage, receiver data | RXD-A | $I_O = -20 \mu A$, for in-band $E_e \le 0.3 \mu W/cm^2$ | V _{CC} -0.6 | | | · v |
| | | RXD-B | $I_O = -20 \mu A$, for in-band $E_e \le 0.3 \mu W/cm^2$ | V _{CC} -1.2 | | | |
| I _I L | Low-level input current, transmitter data | liL(TXD) | $GND \le V_{IL(TXD)} \le 0.3 \text{ V}$ | -2 | | 2 | μΑ |
| ۱н | High-level input current, transmitter data | lih(TXD) | V _{IH} (TXD) = 4.25 V | | 40 | 250 | μΑ |
| νT | On-state voltage LED anode | VT(LEDA) | I _{I(LED)} = 400 mA at 25°C V _{IH} (TXD) = 4.25 V | | | 2.78 | V |
| I _{D(lkg)} | OFF-state leakage current, LED anode | I _{D(lkg)} (LEDA) | V _I (LEDA) = V _{CC} = 5.25 V V _I (TXD) = 0.3 V | | | 250 | μΑ |
| ICC1 | I _{CC1} Supply current, idle state | | $V_{CC} = 5.25 \text{ V}$ $V_{I(TXD)} = V_{IL}, E_{e} = 0$ | | 3 | 5.1 | mA |
| I _{CC2} | Supply current, active receiver | | $\begin{aligned} &V_{CC} = 5.25 \text{ V} \\ &V_{I(TXD)} = V_{IL}, \\ &E_{e} \le 500 \text{ nW/cm}^2 \end{aligned}$ | | 4 | 18 | mA |

optical specifications

| | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------------|--|---|-----|-----|-----|-----------------|
| 2 ₀ 1/2 | Receiver viewing angle | | ±15 | | | ٥ |
| | Effective detector area | | | 0.2 | | cm ² |
| l _e | Transmitter radiant intensity, logic high | $V_{IH(TXD)} = 4.25 \text{ V}$ $I_{I(LED)} = 450 \text{ mA},$ $\Phi^{1/2} \le 15^{\circ}, T_{A} = 25^{\circ}C$ | 100 | 177 | | mW/sr |
| | | $V_{IH(TXD)} = 4.25 \text{ V}$ $I_{I(LED)} = 450 \text{ mA},$ $\Phi^{1/2} \le 15^{\circ}, 0^{\circ}\text{C} \le T_{A} \le 70^{\circ}\text{C}$ | 80 | 177 | | mW/sr |
| λ_{p} | Transmitter peak-emission wavelength | | | 875 | | nm |
| $\Delta \lambda^{1/2}$ | Transmitter spectral-line half-width | | | 35 | | nm |
| 2Φ ^{1/2} | Transmitter viewing angle | | ±15 | | ±30 | ٥ |
| | Receiver peak-emission sensitivity wave length | | | 880 | | nm |

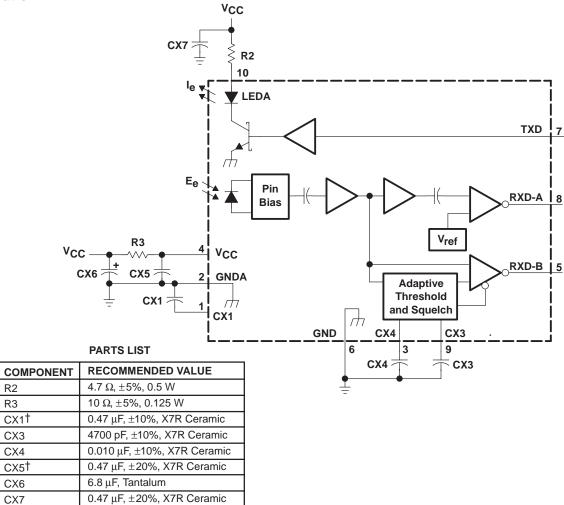
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switching characteristics

| PARAMETER | | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|---|-----------|--|-----|-----|-----|------|
| 1 (5) 10 | Transmitter radiant intensity pulse width | | l _e (PW)(TXD) = 1.6 μs at 115.2k pulses/s | 1.5 | 1.6 | 1.8 | μs |
| le(PW) Transmitter radiant intensity pulse width | | | I _{e(PW)(TXD)} = 125 ns at 2M pulses/s | 115 | 125 | 135 | ns |
| le | Transmitter radiant intensity | Rise time | l _{e(PW)(TXD)} = 125 ns at 2M pulses/s | | | 40 | ns |
| | | Fall time | | | | 40 | 115 |
| PW | Pulse width | RXD-A | Φ1/2 =< 15° | 1 | | 7.5 | μs |
| FVV | | RXD-B | ₩ = 5 13 | 75 | | 185 | ns |
| PW | PW Pulse width, RXD-B (ASK) | | 500 kHz, 50% duty cycle carrier ASK | 0.7 | 1 | 1.3 | μs |
| tL | Receiver latency time | RXD-A | - | | 0.5 | · | ms |
| | Neceiver laterity title | RXD-B | | | | | 1115 |

APPLICATION INFORMATION

schematic



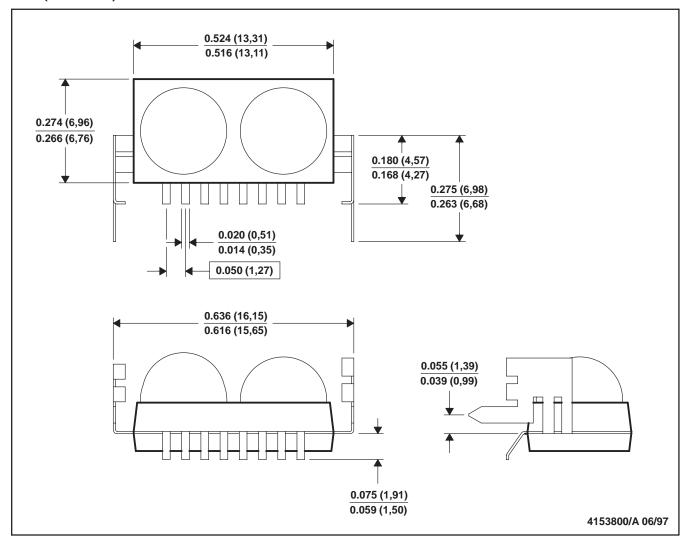
[†] CX1 and CX5 must be placed within 0.7 cm of the TSLM1100 to obtain optimum noise immunity.



MECHANICAL DATA

SRA (R-PSIP-T8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

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